

© Copyright SEK Svensk Elstandard. Reproduction in any form without permission is prohibited.

Reläer – Halvledarreläer – Säkerhet

*Solid-state relays –
Safety requirements*

Som svensk standard gäller europastandarden EN IEC 62314:2024. Den svenska standarden innehåller den officiella engelska språkversionen av EN IEC 62314:2024.

Nationellt förord

Europastandarden EN IEC 62314:2024

består av:
europastandardens ikraftsättningsdokument, utarbetat inom CENELEC

– **IEC 62314, Second edition, 2022 - Solid-state relays - Safety requirements**

utarbetad inom International Electrotechnical Commission, IEC.

Tidigare fastställd svensk standard SS-EN 62314, utg 1:2007 med eventuella tillägg, ändringar och rättelser gäller ej fr o m 2027-11-30.

ICS 29.120.70

Denna standard är fastställd av SEK Svensk Elstandard, som också kan lämna upplysningar om **sakinnehållet** i standarden.
Postadress: Box 1042, 172 21 Sundbyberg
Telefon: 08 - 444 14 00.
E-post: sek@elstandard.se. Internet: elstandard.se

Standarder underlättar utvecklingen och höjer elsäkerheten

Det finns många fördelar med att ha gemensamma tekniska regler för bl a mätning, säkerhet och provning och för utförande, skötsel och dokumentation av elprodukter och elanläggningar.

Genom att utforma sådana standarder blir säkerhetsfordringar tydliga och utvecklingskostnaderna rimliga samtidigt som marknadens acceptans för produkten eller tjänsten ökar.

Många standarder inom elområdet beskriver tekniska lösningar och metoder som åstadkommer den elsäkerhet som föreskrivs av svenska myndigheter och av EU.

SEK är Sveriges röst i standardiseringsarbetet inom elområdet

SEK Svensk Elstandard svarar för standardiseringen inom elområdet i Sverige och samordnar svensk medverkan i internationell och europeisk standardisering. SEK är en ideell organisation med frivilligt deltagande från svenska myndigheter, företag och organisationer som vill medverka till och påverka utformningen av tekniska regler inom elektrotekniken.

SEK samordnar svenska intressenters medverkan i SEKs tekniska kommittéer och stödjer svenska experters medverkan i internationella och europeiska projekt.

Stora delar av arbetet sker internationellt

Utformningen av standarder sker i allt väsentligt i internationellt och europeiskt samarbete. SEK är svensk nationalkommitté av International Electrotechnical Commission (IEC) och Comité Européen de Normalisation Electrotechnique (CENELEC).

Standardiseringsarbetet inom SEK är organiserat i referensgrupper bestående av ett antal tekniska kommittéer som speglar hur arbetet inom IEC och CENELEC är organiserat.

Arbetet i de tekniska kommittéerna är öppet för alla svenska organisationer, företag, institutioner, myndigheter och statliga verk. Den årliga avgiften för deltagandet och intäkter från försäljning finansierar SEKs standardiseringsverksamhet och medlemsavgift till IEC och CENELEC.

Var med och påverka!

Den som deltar i SEKs tekniska kommittéarbete har möjlighet att påverka framtida standarder och får tidig tillgång till information och dokumentation om utvecklingen inom sitt teknikområde. Arbetet och kontakterna med kollegor, kunder och konkurrenter kan gynnsamt påverka enskilda företags affärsutveckling och bidrar till deltagarnas egen kompetensutveckling.

Du som vill dra nytta av dessa möjligheter är välkommen att kontakta SEKs kansli för mer information.

SEK Svensk Elstandard

Box 1042
172 21 Sundbyberg
Tel 08-444 14 00
elstandard.se

English Version

Solid-state relays - Safety requirements
(IEC 62314:2022)

Relais statiques - Exigences de sécurité
(IEC 62314:2022)

Halbleiterrelais - Sicherheitsanforderungen
(IEC 62314:2022)

This European Standard was approved by CENELEC on 2024-10-16. CENELEC members are bound to comply with the CEN/CENELEC Internal Regulations which stipulate the conditions for giving this European Standard the status of a national standard without any alteration.

Up-to-date lists and bibliographical references concerning such national standards may be obtained on application to the CEN-CENELEC Management Centre or to any CENELEC member.

This European Standard exists in three official versions (English, French, German). A version in any other language made by translation under the responsibility of a CENELEC member into its own language and notified to the CEN-CENELEC Management Centre has the same status as the official versions.

CENELEC members are the national electrotechnical committees of Austria, Belgium, Bulgaria, Croatia, Cyprus, the Czech Republic, Denmark, Estonia, Finland, France, Germany, Greece, Hungary, Iceland, Ireland, Italy, Latvia, Lithuania, Luxembourg, Malta, the Netherlands, Norway, Poland, Portugal, Republic of North Macedonia, Romania, Serbia, Slovakia, Slovenia, Spain, Sweden, Switzerland, Türkiye and the United Kingdom.



European Committee for Electrotechnical Standardization
Comité Européen de Normalisation Electrotechnique
Europäisches Komitee für Elektrotechnische Normung

CEN-CENELEC Management Centre: Rue de la Science 23, B-1040 Brussels

European foreword

The text of document 94/670/FDIS, future edition 2 of IEC 62314, prepared by TC 94 "Electrical relays" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN IEC 62314:2024.

The following dates are fixed:

- latest date by which the document has to be implemented at national (dop) 2025-11-30 level by publication of an identical national standard or by endorsement
- latest date by which the national standards conflicting with the (dow) 2027-11-30 document have to be withdrawn

This document supersedes EN 62314:2006 and all of its amendments and corrigenda (if any).

Attention is drawn to the possibility that some of the elements of this document may be the subject of patent rights. CENELEC shall not be held responsible for identifying any or all such patent rights.

Any feedback and questions on this document should be directed to the users' national committee. A complete listing of these bodies can be found on the CENELEC website.

Endorsement notice

The text of the International Standard IEC 62314:2022 was approved by CENELEC as a European Standard without any modification.

In the official version, for Bibliography, the following notes have to be added for the standard indicated:

IEC 60947 series	NOTE	Approved as EN IEC 60947 series
IEC 60947-4-3:2020	NOTE	Approved as EN IEC 60947-4-3:2020 (not modified)
IEC 61000-4 series	NOTE	Approved as EN 61000-4 series
IEC 61058 series	NOTE	Approved as EN IEC 61058 series
IEC 61058-1:2016	NOTE	Approved as EN IEC 61058-1:2018 (not modified)
IEC 61810-7:2006	NOTE	Approved as EN 61810-7:2006 (not modified)
ISO 12100:2010	NOTE	Approved as EN ISO 12100:2010 (not modified)
ISO 14971	NOTE	Approved as EN ISO 14971

Annex ZA (normative)

Normative references to international publications with their corresponding European publications

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE 1 Where an International Publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

NOTE 2 Up-to-date information on the latest versions of the European Standards listed in this annex is available here: www.cencenelec.eu.

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 60038 (mod)	2009	IEC standard voltages	EN 60038	2011
IEC 60050-444	2002	International Electrotechnical Vocabulary - Part 444: Elementary relays	-	-
IEC 60068-2-1	2007	Environmental testing - Part 2-1: Tests - Test A: Cold	EN 60068-2-1	2007
IEC 60068-2-2	2007	Environmental testing - Part 2-2: Tests - Test B: Dry heat	EN 60068-2-2	2007
IEC 60068-2-14	2009	Environmental testing - Part 2-14: Tests - Test N: Change of temperature	EN 60068-2-14	2009
IEC 60068-2-20	2021	Environmental testing - Part 2-20: Tests - Test Ta and Tb: Test methods for solderability and resistance to soldering heat of devices with leads	EN IEC 60068-2-20	2021
IEC 60068-2-78	2012	Environmental testing - Part 2-78: Tests - Test Cab: Damp heat, steady state	EN 60068-2-78	2013
IEC 60112	2020	Method for the determination of the proof and the comparative tracking indices of solid insulating materials	EN IEC 60112	2020
IEC 60664-1	2020	Insulation coordination for equipment within low-voltage supply systems - Part 1: Principles, requirements and tests	EN IEC 60664-1	2020
IEC 60664-3	2016	Insulation coordination for equipment within low-voltage systems - Part 3: Use of coating, potting or moulding for protection against pollution	EN 60664-3	2017
IEC 60669-1 (mod)	2017	Switches for household and similar fixed-electrical installations - Part 1: General requirements	EN 60669-1	2018
-	-		+AC	2018-11

EN IEC 62314:2024 (E)

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 60695-2-11	2021	Fire hazard testing - Part 2-11: Glowing/hot-wire based test methods - Glow-wire flammability test method for end products (GWEPT)	EN IEC 60695-2-11	2021
IEC 60695-2-12	2021	Fire hazard testing - Part 2-12: Glowing/hot-wire based test methods - Glow-wire flammability index (GWFI) test method for materials	EN IEC 60695-2-12	2021
IEC 60695-10-2	2014	Fire hazard testing - Part 10-2: Abnormal heat - Ball pressure test method	EN 60695-10-2	2014
IEC 60747-5-5	2020	Semiconductor devices - Part 5-5: Optoelectronic devices - Photocouplers	EN IEC 60747-5-5	2020
IEC 60999-1	1999	Connecting devices - Electrical copper conductors - Safety requirements for screw-type and screwless-type clamping units - Part 1: General requirements and particular requirements for clamping units for conductors from 0,2 mm ² up to 35 mm ² (included)	EN 60999-1	2000
IEC 61000-4-2	2008	Electromagnetic compatibility (EMC) - Part 4-2: Testing and measurement techniques - Electrostatic discharge immunity test	EN 61000-4-2	2009
IEC 61000-4-3	2020	Electromagnetic compatibility (EMC) - Part 4-3 : Testing and measurement techniques - Radiated, radio-frequency, electromagnetic field immunity test	EN IEC 61000-4-3	2020
IEC 61000-4-4	2012	Electromagnetic compatibility (EMC) - Part 4-4: Testing and measurement techniques - Electrical fast transient/burst immunity test	EN 61000-4-4	2012
IEC 61000-4-5	2014	Electromagnetic compatibility (EMC) - Part 4-5: Testing and measurement techniques - Surge immunity test	EN 61000-4-5	2014
+ A1	2017		+ A1	2017
IEC 61000-4-6	2013	Electromagnetic compatibility (EMC) - Part 4-6: Testing and measurement techniques - Immunity to conducted disturbances, induced by radio-frequency fields	EN 61000-4-6	2014
IEC 61000-4-8	2009	Electromagnetic compatibility (EMC) - Part 4-8: Testing and measurement techniques - Power frequency magnetic field immunity test	EN 61000-4-8	2010
IEC 61000-4-11	2020	Electromagnetic compatibility (EMC) - Part 4-11: Testing and measurement techniques - Voltage dips, short interruptions and voltage variations immunity tests for equipment with input current up to 16 A per phase	EN IEC 61000-4-11	2020

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 61000-4-34	2005	Electromagnetic compatibility (EMC) - Part 4-34: Testing and measurement techniques - Voltage dips, short interruptions and voltage variations immunity tests for equipment with input current more than 16 A per phase	EN 61000-4-34	2007
+ A1	2009		+ A1	2009
IEC 61180	2016	High-voltage test techniques for low-voltage equipment - Definitions, test and procedure requirements, test equipment	EN 61180	2016
IEC 61210 (mod)	2010	Connecting devices - Flat quick-connect terminations for electrical copper conductors - Safety requirements	EN 61210	2010
IEC 61760-1	2020	Surface mounting technology - Part 1: Standard method for the specification of surface mounting components (SMDs)	EN IEC 61760-1	2020
IEC 61810-1	2015	Electromechanical elementary relays - Part 1: General and safety requirements	EN 61810-1	2015
+ A1	2019		+ A1	2020
IEC 61984	2008	Connectors - Safety requirements and tests	EN 61984	2009
IEC 62368-1	2018	Audio/video, information and communication technology equipment - Part 1: Safety requirements	EN IEC 62368-1	2020
IEC/TS 62993	2017	Guidance for determination of clearances, creepage distances and requirements for solid insulation for equipment with a rated voltage above 1 000 V AC and 1 500 V DC, and up to 2 000 V AC and 3 000 V DC	-	-
CISPR 11 (mod)	2015	Industrial, scientific and medical equipment - Radio-frequency disturbance characteristics - Limits and methods of measurement	EN 55011	2016
+ A1	2016		+ A1	2017
-	-		+ A11	2020
+ A2	2019		+ A2	2021
CISPR 32	2015	Electromagnetic compatibility of multimedia equipment - Emission requirements	EN 55032	2015



IEC 62314

Edition 2.0 2022-07

INTERNATIONAL STANDARD

NORME INTERNATIONALE

Solid-state relays – Safety requirements

Relais statiques – Exigences de sécurité

INTERNATIONAL
ELECTROTECHNICAL
COMMISSION

COMMISSION
ELECTROTECHNIQUE
INTERNATIONALE

ICS 29.120.70

ISBN 978-2-8322-1245-5

**Warning! Make sure that you obtained this publication from an authorized distributor.
Attention! Veuillez vous assurer que vous avez obtenu cette publication via un distributeur agréé.**

CONTENTS

FOREWORD.....	5
1 Scope.....	7
2 Normative references	8
3 Terms and definitions	10
3.1 Terms and definitions related to relays.....	10
3.2 Terms and definitions related to insulation coordination (see Clause 11)	14
4 Characteristics of solid-state relays	16
5 Rated values	17
5.1 Rated and limiting values for output circuits and for insulation coordination	17
5.2 Load category	17
5.3 Rated and limiting values for control circuits	18
5.4 Overload current profile	19
5.5 Normal service, transport and storage conditions	19
5.5.1 Ambient temperature	19
5.5.2 Atmospheric conditions.....	19
5.6 Normal mounting conditions	19
6 Provisions for test.....	19
6.1 Type test.....	19
6.2 Routine test	20
7 Documentation and marking	21
7.1 Data.....	21
7.2 Instructions for installation, operation and maintenance	22
7.3 Marking.....	22
8 Temperature-rise	22
8.1 General.....	22
8.2 Test conditions	23
9 Basic operating function	23
9.1 OFF-state leakage current measurement	23
9.2 ON-state voltage drop measurement.....	23
10 Electrical endurance	23
10.1 Overload test	23
10.1.1 General	23
10.1.2 Overload capability test procedure.....	25
10.2 Endurance test.....	25
10.3 Verification.....	25
11 Clearances and creepage distances	27
11.1 General.....	27
11.2 Basis for insulation coordination	27
11.2.1 Basic principles	27
11.2.2 Rated impulse withstand voltage.....	27
11.2.3 Insulating materials	27
11.3 Requirements and dimensioning rules.....	28
11.3.1 Dimensioning of clearances.....	28
11.3.2 Dimensioning of creepage distances.....	29
11.3.3 Requirements for solid insulating materials.....	31
11.4 Tests and measurements	31

11.4.1	Tests	31
11.4.2	Measurement of creepage distances and clearances	31
11.4.3	Electrical tests for solid insulation	31
11.5	Alternative test methods	32
12	Terminations	32
12.1	Quick-connect terminations	32
12.1.1	Purpose	32
12.1.2	Recommended values	33
12.1.3	Requirements	33
12.2	Screw-type and screwless-type clamping-units	34
12.3	Solder terminals – Resistance to soldering heat	34
12.3.1	General	34
12.3.2	Solder pins	34
12.3.3	Terminals for surface mounting (SMD)	35
12.3.4	Other solder terminations (e.g. soldering lugs)	35
12.4	Sockets	35
13	Heat and fire resistance	35
13.1	Materials	35
13.2	Glow-wire test	36
13.3	Ball pressure test	36
14	Electromagnetic compatibility (EMC)	37
14.1	General	37
14.2	Immunity	37
14.3	Emission	37
Annex A (normative)	Test for solid-state relays intended for self ballasted lamp loads	38
Annex B (informative)	Risk assessment	41
B.1	General	41
B.2	Risk assessment procedure	41
B.3	Achieving tolerable risk	42
B.4	An application of risk assessment procedures (proposal for the user)	44
Annex C (normative)	Pollution degree	46
Annex D (normative)	Rated impulse withstand voltages	47
Annex E (normative)	Tests for EMC	48
E.1	General	48
E.2	EMC immunity	48
E.2.1	General	48
E.2.2	Electrostatic discharges	49
E.2.3	Radiated radio-frequency electromagnetic fields	49
E.2.4	Electrical fast transients/bursts	49
E.2.5	Surges	49
E.2.6	Conducted disturbances induced by radio-frequency fields	49
E.2.7	Immunity to power-frequency magnetic fields	49
E.2.8	Voltage dips and voltage interruptions	49
E.2.9	Summary of immunity test conditions	49
E.3	EMC radiated and conducted emission	52
E.3.1	General	52
E.3.2	Conducted radio-frequency emission tests	52
E.3.3	Radiated radio-frequency emission tests	52

Bibliography.....	53
Figure A.1 – Circuit diagram for testing solid-state relay	38
Figure B.1 – Iterative process of risk assessment and risk reduction.....	41
Figure B.2 – Risk reduction.....	43
Table 1 – Load categories.....	18
Table 2 – Type testing	20
Table 3 – Routine tests	21
Table 4 – Required data	21
Table 5 – Minimum requirements for overload capability test conditions.....	24
Table 6 – Endurance test	26
Table 7 – Minimum clearance	29
Table 8 – Minimum creepage distances for solid-state relays.....	30
Table 9 – Preconditioning	32
Table 10 – Cross-sectional areas for conductors depending on the resistive current carried by the terminal	34
Table 11 – Test conditions for test Tb	35
Table A.1 – Values for I_{peak} and I^2t depending on the type of distribution system	39
Table A.2 – Calculated circuit parameters	39
Table A.3 – Number of operations for endurance test	40
Table B.1 – Examples for the relation between failure mode, effects and hazard	44
Table B.2 – Severity of harm.....	44
Table B.3 – Probability of harm.....	45
Table B.4 – Risk category	45
Table D.1 – Rated impulse withstand voltages (waveform: 1,2/50 µs) for solid-state relays connected directly to the mains	47
Table E.1 – Selection criteria for environmental conditions	48
Table E.2 – Specific performance criteria when electro-magnetic disturbances are present	49
Table E.3 – Immunity tests for industrial environments	50
Table E.4 – Immunity tests for residential, commercial and light-industrial environments	51
Table E.5 – Terminal disturbance voltage limits for conducted radio-frequency emission (for control supply input)	52
Table E.6 – Radiated emission test limits.....	52

INTERNATIONAL ELECTROTECHNICAL COMMISSION

SOLID-STATE RELAYS – SAFETY REQUIREMENTS**FOREWORD**

- 1) The International Electrotechnical Commission (IEC) is a worldwide organization for standardization comprising all national electrotechnical committees (IEC National Committees). The object of IEC is to promote international co-operation on all questions concerning standardization in the electrical and electronic fields. To this end and in addition to other activities, IEC publishes International Standards, Technical Specifications, Technical Reports, Publicly Available Specifications (PAS) and Guides (hereafter referred to as "IEC Publication(s)"). Their preparation is entrusted to technical committees; any IEC National Committee interested in the subject dealt with may participate in this preparatory work. International, governmental and non-governmental organizations liaising with the IEC also participate in this preparation. IEC collaborates closely with the International Organization for Standardization (ISO) in accordance with conditions determined by agreement between the two organizations.
- 2) The formal decisions or agreements of IEC on technical matters express, as nearly as possible, an international consensus of opinion on the relevant subjects since each technical committee has representation from all interested IEC National Committees.
- 3) IEC Publications have the form of recommendations for international use and are accepted by IEC National Committees in that sense. While all reasonable efforts are made to ensure that the technical content of IEC Publications is accurate, IEC cannot be held responsible for the way in which they are used or for any misinterpretation by any end user.
- 4) In order to promote international uniformity, IEC National Committees undertake to apply IEC Publications transparently to the maximum extent possible in their national and regional publications. Any divergence between any IEC Publication and the corresponding national or regional publication shall be clearly indicated in the latter.
- 5) IEC itself does not provide any attestation of conformity. Independent certification bodies provide conformity assessment services and, in some areas, access to IEC marks of conformity. IEC is not responsible for any services carried out by independent certification bodies.
- 6) All users should ensure that they have the latest edition of this publication.
- 7) No liability shall attach to IEC or its directors, employees, servants or agents including individual experts and members of its technical committees and IEC National Committees for any personal injury, property damage or other damage of any nature whatsoever, whether direct or indirect, or for costs (including legal fees) and expenses arising out of the publication, use of, or reliance upon, this IEC Publication or any other IEC Publications.
- 8) Attention is drawn to the Normative references cited in this publication. Use of the referenced publications is indispensable for the correct application of this publication.
- 9) Attention is drawn to the possibility that some of the elements of this IEC Publication may be the subject of patent rights. IEC shall not be held responsible for identifying any or all such patent rights.

IEC 62314 has been prepared by IEC technical committee 94: All-or-nothing electrical relays. It is an International Standard.

This second edition cancels and replaces the first edition published in 2006. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) addition of load categories for DC load;
- b) addition of load category for self-ballasted lamp load;
- c) addition of "sockets" terminal;
- d) update of references;
- e) introduction of the requirement of EMC;
- f) restructuring of the whole document.

The text of this International Standard is based on the following documents:

Draft	Report on voting
94/670/FDIS	94/701/RVD

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this International Standard is English.

This document was drafted in accordance with ISO/IEC Directives, Part 2, and developed in accordance with ISO/IEC Directives, Part 1 and ISO/IEC Directives, IEC Supplement, available at www.iec.ch/members_experts/refdocs. The main document types developed by IEC are described in greater detail at www.iec.ch/publications.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under webstore.iec.ch in the data related to the specific document. At this date, the document will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

SOLID-STATE RELAYS – SAFETY REQUIREMENTS

1 Scope

This document applies to particular all-or-nothing electrical relays denominated solid-state relays intended for performing electrical operations by single step function changes to the state of electric circuits between the OFF-state and the ON-state and vice versa.

This document deals with solid-state relays which are intended for incorporation in other products or equipment. As such, solid-state relays are considered to be components and this document defines the basic safety-related and functional requirements for solid-state relays as stand-alone components.

Such solid-state relays are incorporated in products or equipment which themselves comply with the relevant product and/or application standard(s) to meet their intended application.

NOTE The following are examples of such applications:

- general industrial equipment;
- electrical facilities;
- electrical machines;
- electrical appliances;
- office communications;
- building automation and environmental control;
- automation and process control;
- electrical installation engineering;
- medical engineering;
- telecommunications;
- vehicle engineering;
- transportation engineering;
- lighting control.

Solid state relay as apparatus:

Where the solid-state relay is specified as apparatus with a function to the end-user, requirements on EMC are given in this document.

Solid state relay as component:

There are no EMC requirements for solid-state relays intended for incorporation into the equipment by the equipment manufacturer, because the performance strongly depends on the application into the equipment.

The object of this document is to state:

- the characteristics of solid-state relays
- the requirements which apply to solid-state relays with reference to
 - a) electrical safety;
 - b) their operation and behaviour;
 - c) their dielectric properties;
 - d) EMC;

- the tests verifying that the requirements have been met, and the test methods to be adopted;
- the information to be given with the solid-state relay or in the product documentation.

Solid-state switching devices with monolithic structures fall within the scope of IEC sub-committee 47E and are not covered in this document.

Semiconductor controllers and contactors fall within the scope of the IEC 60947 series of standards – low-voltage switchgear and controlgear – developed by IEC subcommittee 121A and are not covered in this document.

2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60038:2009, *IEC standard voltages*

IEC 60050-444:2002, *International Electrotechnical Vocabulary (IEV) – Part 444: Elementary relays* (available at www.electropedia.org)

IEC 60068-2-1:2007, *Environmental testing – Part 2-1: Tests – Test A: Cold*

IEC 60068-2-2:2007, *Environmental testing – Part 2-2: Tests – Test B: Dry heat*

IEC 60068-2-14:2009, *Environmental testing – Part 2-14: Tests – Test N: Change of temperature*

IEC 60068-2-20:2021, *Environmental testing – Part 2-20: Tests – Test Ta and Tb: Test methods for solderability and resistance to soldering heat of devices with leads*

IEC 60068-2-78:2012, *Environmental testing – Part 2-78: Tests – Test Cab: Damp heat, steady state*

IEC 60112:2020, *Method for the determination of the proof and the comparative tracking indices of solid insulating materials*

IEC 60664-1:2020, *Insulation coordination for equipment within low-voltage systems – Part 1: Principles, requirements and tests*

IEC 60664-3:2016, *Insulation coordination for equipment within low-voltage systems – Part 3: Use of coating, potting or moulding for protection against pollution*

IEC 60669-1:2017, *Switches for household and similar fixed-electrical installations – Part 1: General requirements*

IEC 60695-2-11:2021, *Fire hazard testing – Part 2-11: Glowing/hot-wire based test methods – Glow-wire flammability test method for end-products (GWEPT)*

IEC 60695-2-12:2021, *Fire hazard testing – Part 2-12: Glowing/hot-wire based test methods – Glow-wire flammability index (GWFI) test method for materials*

IEC 60695-10-2:2014, *Fire hazard testing – Part 10-2: Abnormal heat – Ball pressure test method*

IEC 60747-5-5:2020, *Semiconductor devices – Part 5-5: Optoelectronic devices – Photocouplers*

IEC 60999-1:1999, *Connecting devices – Electrical copper conductors – Safety requirements for screw-type and screwless-type clamping units – Part 1: General requirements and particular requirements for clamping units for conductors from 0,2 mm² up to 35 mm² (included)*

IEC 61000-4-2:2008, *Electromagnetic compatibility (EMC) – Part 4-2: Testing and measurement techniques – Electrostatic discharge immunity test*

IEC 61000-4-3:2020, *Electromagnetic compatibility (EMC) – Part 4-3: Testing and measurement techniques – Radiated, radio-frequency, electromagnetic field immunity test*

IEC 61000-4-4:2012, *Electromagnetic compatibility (EMC) – Part 4-4: Testing and measurement techniques – Electrical fast transient/burst immunity test*

IEC 61000-4-5:2014, *Electromagnetic compatibility (EMC) – Part 4-5: Testing and measurement techniques – Surge immunity test*
IEC 61000-4-5:2014/AMD1:2017

IEC 61000-4-6:2013, *Electromagnetic compatibility (EMC) – Part 4-6: Testing and measurement techniques – Immunity to conducted disturbances, induced by radio-frequency fields*

IEC 61000-4-8:2009, *Electromagnetic compatibility (EMC) – Part 4-8: Testing and measurement techniques – Power frequency magnetic field immunity test*

IEC 61000-4-11:2020, *Electromagnetic compatibility (EMC) – Part 4-11: Testing and measurement techniques – Voltage dips, short interruptions and voltage variations immunity tests for equipment with input current up to 16 A per phase*

IEC 61000-4-34:2005, *Electromagnetic compatibility (EMC) – Part 4-34: Testing and measurement techniques – Voltage dips, short interruptions and voltage variations immunity tests for equipment with input current more than 16 A per phase*
IEC 61000-4-34:2005/AMD1:2009

IEC 61180:2016, *High-voltage test techniques for low-voltage equipment – Definitions, test and procedure requirements, test equipment*

IEC 61210:2010, *Connecting devices – Flat quick-connect terminations for electrical copper conductors – Safety requirements*

IEC 61760-1:2020, *Surface mounting technology – Part 1: Standard method for the specification of surface mounting components (SMDs)*

IEC 61810-1:2015, *Electromechanical elementary relays – Part 1: General and safety requirements*
IEC 61810-1:2015/AMD1:2019

IEC 61984:2008, *Connectors – Safety requirements and tests*

IEC 62368-1:2018, *Audio/video, information and communication technology equipment – Part 1: Safety requirements*

IEC TS 62993:2017, *Guidance for determination of clearances, creepage distances and requirements for solid insulation for equipment with a rated voltage above 1 000 V AC and 1 500 V DC, and up to 2 000 V AC and 3 000 V DC*

CISPR 11:2015, *Industrial, scientific and medical equipment – Radio-frequency disturbance characteristics – Limits and methods of measurement*
CISPR 11:2015/AMD1:2016
CISPR 11:2015/AMD2:2019

CISPR 32:2015, *Electromagnetic compatibility of multimedia equipment – Emission requirements*